



RoHS compliant
TX-1550/RX-1310 nm Single-mode, Single-fiber (Bi-directional) Transceiver
1x9, SC Simplex Connector, 3.3V (22dB Margin)
155 Mbps ATM/SONET OC-3/SDH STM-1/Fast Ethernet



Features

- RoHS compliant
- Compatible with 155 Mbps ATM and SONET OC-3 SDH STM-1
- Industry standard 1×9 footprint
- SC Connector
- Single power supply 3.3 V
- Differential PECL inputs and outputs
- Class 1 laser product complies with EN 60825-1

Ordering Information

PART NUMBER	TX	RX	VOLTAGE	TEMPERATURE
LSB2-A3M-PC-N5-SA	1550 nm	1310 nm	3.3 V	0 °C to 70 °C
LSB2-A3M-PI-N5-SA	1550 nm	1310 nm	3.3 V	-40 °C to 85 °C



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Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Storage Temperature	T_S	-40	85	°C	
Supply Voltage	V_{CC}	-0.5	4.0	V	
Input Voltage	V_{IN}	-0.5	V_{CC}	V	
Soldering Temperature	T_{SOLD}	---	260	°C	10 seconds on leads

Operating Environment

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Case Operating Temperature (LSB2-A3M-PC-N5-SA)	T_C	0	70	°C	
Case Operating Temperature (LSB2-A3M-PI-N5-SA)	T_C	-40	85	°C	
Supply Voltage	V_{CC}	3.1	3.5	V	
Supply Current	$I_{TX} + I_{RX}$	---	250	mA	

Transmitter Electro-optical Characteristics

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Data Rate	B	50	155	200	Mb/s	
Output Optical Power 9/125 μ m fiber	P_{out}	-9	---	-3	dBm	Average
Extinction Ratio	ER	10	---	---	dB	
Center Wavelength	λ_C	1480	1550	1580	nm	
Spectral Width (RMS)	$\Delta\lambda$	---	---	3	nm	
Rise/Fall Time, 10%~90%	$T_{r,f}$	---	1	2	ns	
Output Eye	Compliant with Telcordia GR-253-CORE Issue 3 and ITU-T recommendation G-957					
Transmitter Data Input Voltage-High	$V_{IH} - V_{CC}$	-1.1	---	-0.74	V	
Transmitter Data Input Voltage-Low	$V_{IL} - V_{CC}$	-2.0	---	-1.58	V	
Transmitter Data Input Differential Voltage	V_{DIFF}	0.3	---	1.6	V	



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Receiver Electro-optical Characteristics

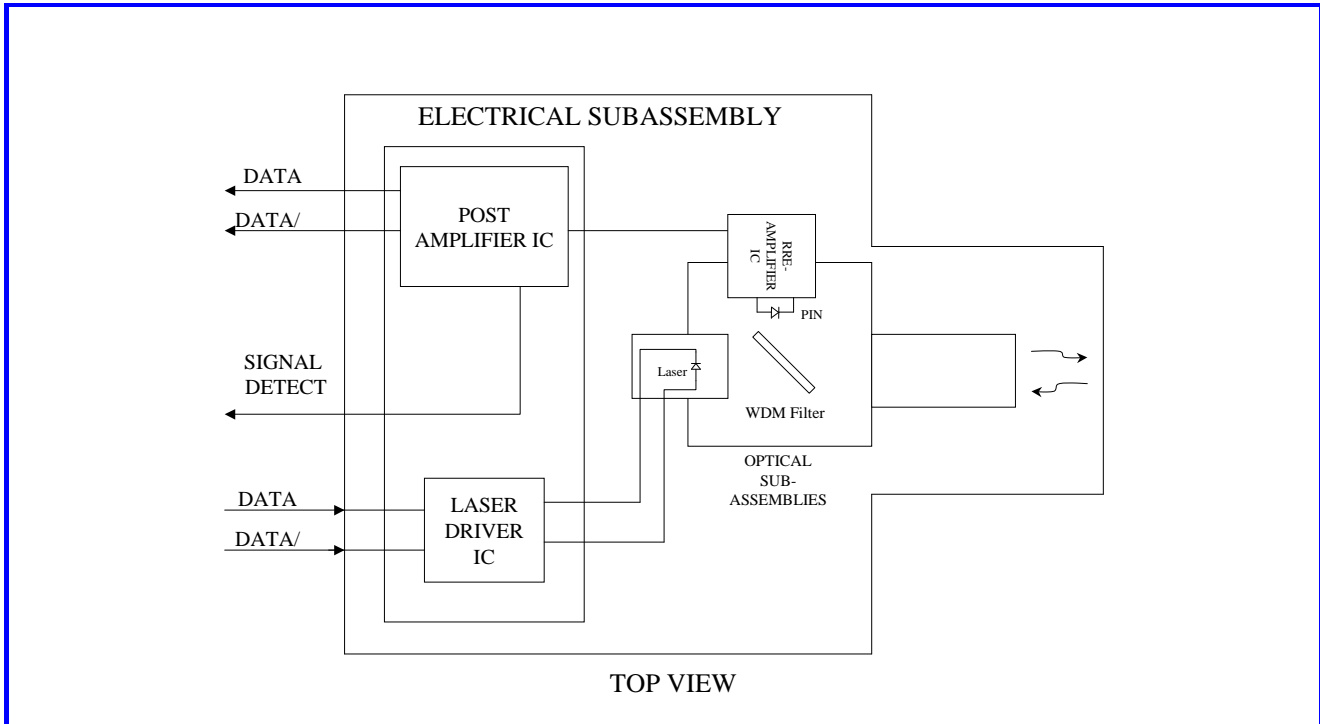
PARAMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Data Rate	B	50	155	200	Mb/s	
Optical Input Power-maximum	P_{IN}	0	---	---	dBm	Note 1
Optical Input Power-minimum (Sensitivity)	P_{IN}	---	---	-31	dBm	Note 1
Operating Center Wavelength	λ_C	1260	---	1360	nm	
Return Loss	RL	---	---	-14	dB	$\lambda=1260\sim 1360\text{nm}$
Signal Detect-Asserted	P_A	---	---	-31	dBm	Average
Signal Detect-Deasserted	P_D	-45	---	---	dBm	Average
Signal Detect-Hysteresis	$P_A - P_D$	1.0	---	---	dB	
Signal Detect Output voltage - High	$V_{OH} - V_{CC}$	-1.1	---	-0.74	V	
Signal Detect Output voltage - Low	$V_{OL} - V_{CC}$	-2.0	---	-1.58	V	
Crosstalk	CRT	---	---	-45	dB	
Data Output Rise, Fall Time	$T_{r,f}$	---	1	2	ns	
Data Output Voltage-High	$V_{OH} - V_{CC}$	-1.1	---	-0.74	V	
Data Output Voltage-Low	$V_{OL} - V_{CC}$	-2.0	---	-1.58	V	

Note 1: The input data is at 155.52 Mbps, $2^{23} - 1$ PRBS data pattern with 72 “1”s and 72 “0”s inserted per the ITU-T recommendation G.958 Appendix 1. The receiver is guaranteed to provide output data with Bit Error Rate (BER) better than or equal to 1×10^{-10} .



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Block Diagram of Transceiver



Transmitter and Receiver Optical Sub-assembly Section

A 1550 nm InGaAsP laser and an InGaAs PIN photodiode integrate with an WDM filter to form a bi-directional single fiber optical subassembly (OSA). The laser of OSA is driven by a LD driver IC which converts differential input LVPECL logic signals into an analog laser driving current. And, The photodiode of OSA is connected to a circuit providing post-amplification quantization, and optical signal detection.

Receiver Signal Detect

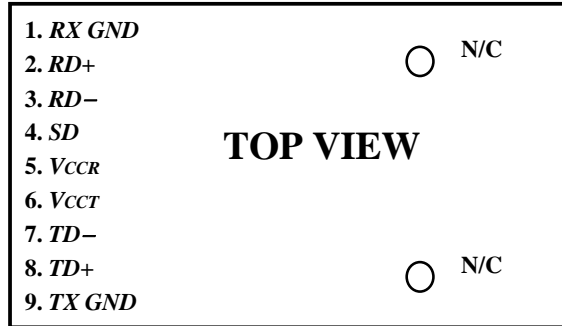
Signal Detect is a basic fiber failure indicator. This is a single-ended LVPECL output. As the input optical power is decreased, Signal Detect will switch from high to low (deassert point) somewhere between sensitivity and the no light input level. As the input optical power is increased from very low levels, Signal Detect will switch back from low to high (assert point). The assert level will be at least 1.0 dB higher than the deassert level.



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Connection Diagram

Pin-Out

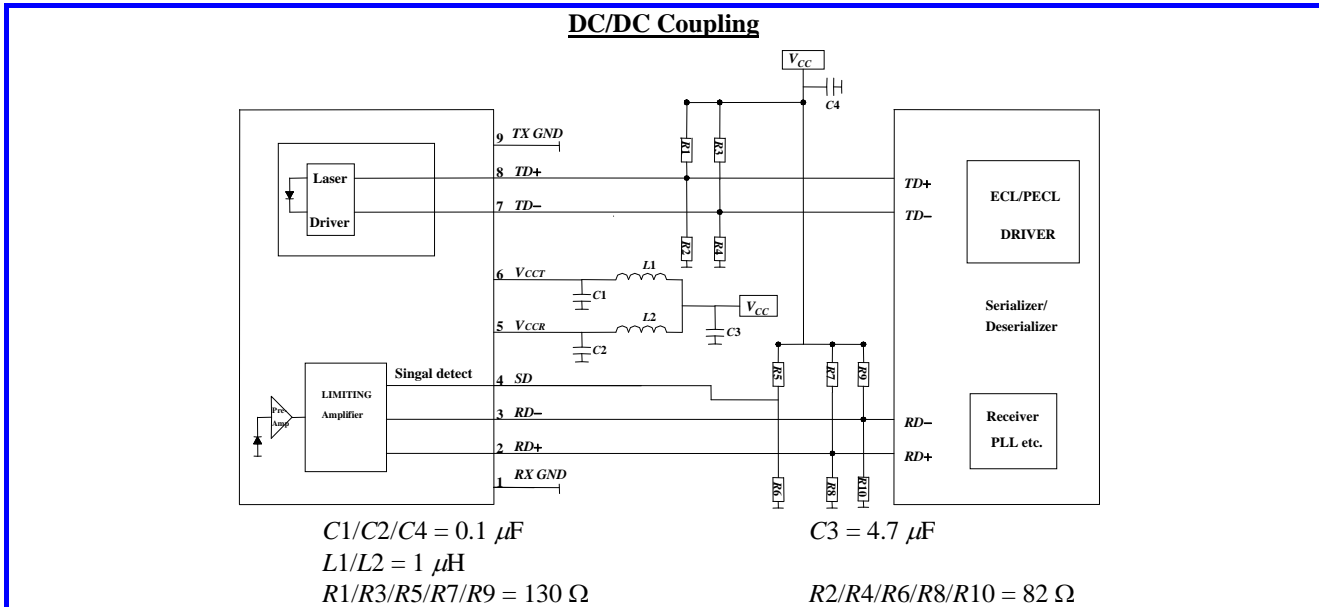


PIN	SYMBOL	DESCRIPTION
1	<i>RX GND</i>	Receiver Signal Ground, Directly connect this pin to the receiver ground plane
2	<i>RD+</i>	<i>RD+</i> is an open-emitter output circuit. Terminate this high-speed differential LVPECL output with standard LVPECL techniques at the follow-on device input pin. (See recommended circuit schematic)
3	<i>RD-</i>	<i>RD-</i> is an open-emitter output circuit. Terminate this high-speed differential LVPECL output with standard LVPECL techniques at the follow-on device input pin. (See recommended circuit schematic)
4	<i>SD</i>	Signal Detect. Normal optical input levels to the receiver result in a logic “1” output, V_{OH} , asserted. Low input optical levels to the receiver result in a fault condition indicated by a logic “0” output V_{OL} , deasserted. Signal Detect is a single-ended LVPECL output. <i>SD</i> can be terminated with LVPECL techniques via $50\ \Omega$ to $V_{CCR} - 2\ \text{V}$. Alternatively, <i>SD</i> can be loaded with a $180\ \Omega$ resistor to <i>RX GND</i> to conserve electrical power with small compromise to signal quality. If Signal Detect output is not used, leave it open-circuited. This Signal Detect output can be used to drive a LVPECL input on an upstream circuit, such as, Signal Detect input or Loss of Signal-bar.
5	V_{CCR}	Receiver Power Supply Provide +3.3 Vdc via the recommended receiver power supply filter circuit. Locate the power supply filter circuit as close as possible to the V_{CCR} pin.
6	V_{CCT}	Transmitter Power Supply Provide +3.3 Vdc via the recommended transmitter power supply filter circuit. Locate the power supply filter circuit as close as possible to the V_{CCT} pin.
7	<i>TD-</i>	Transmitter Data In-Bar Terminate this high-speed differential LVPECL input with standard LVPECL techniques at the transmitter input pin. (See recommended circuit schematic)
8	<i>TD+</i>	Transmitter Data In Terminate this high-speed differential LVPECL input with standard LVPECL techniques at the transmitter input pin. (See recommended circuit schematic)
9	<i>TX GND</i>	Transmitter Signal Ground Directly connect this pin to the transmitter signal ground plane. Directly connect this pin to the transmitter ground plane.



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Recommended Circuit Schematic



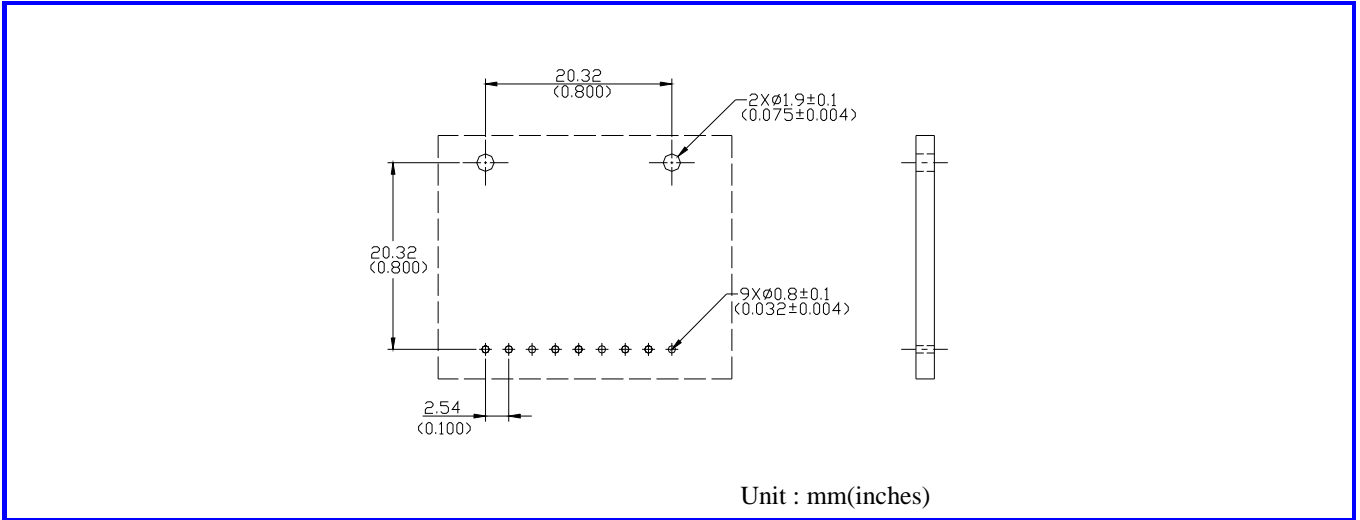
In order to get proper functionality, a recommended circuit is provided in above recommended circuit schematic. When designing the circuit interface, there are a few fundamental guidelines to follow.

- (1) The differential data lines should be treated as 50 Ω Micro strip or strip line transmission lines. This will help to minimize the parasitic inductance and capacitance effects. Locate termination at the received signal end of the transmission line. The length of these lines should be kept short and of equal length.
- (2) For the high speed signal lines, differential signals should be used, not single-ended signals, and these differential signals need to be loaded symmetrically to prevent unbalanced currents which will cause distortion in the signal.
- (3) Multi layer plane PCB is best for distribution of V_{CC} , returning ground currents, forming transmission lines and shielding. Also, it is important to suppress noise from influencing the fiber-optic transceiver performance, especially the receiver circuit.
- (4) A separate proper power supply filter circuits shown in Figure for the transmitter and receiver sections. These filter circuits suppress V_{CC} noise over a broad frequency range, this prevents receiver sensitivity degradation due to V_{CC} noise.
- (5) Surface-mount components are recommended. Use ceramic bypass capacitors for the 0.1 μF capacitors and a surface-mount coil inductor for 1 μH inductor. Ferrite beads can be used to replace the coil inductors when using quieter V_{CC} supplies, but a coil inductor is recommended over a ferrite bead. All power supply components need to be placed physically next to the V_{CC} pins of the receiver and transmitter.
- (6) Use a good, uniform ground plane with a minimum number of holes to provide a low-inductance ground current return for the power supply currents.



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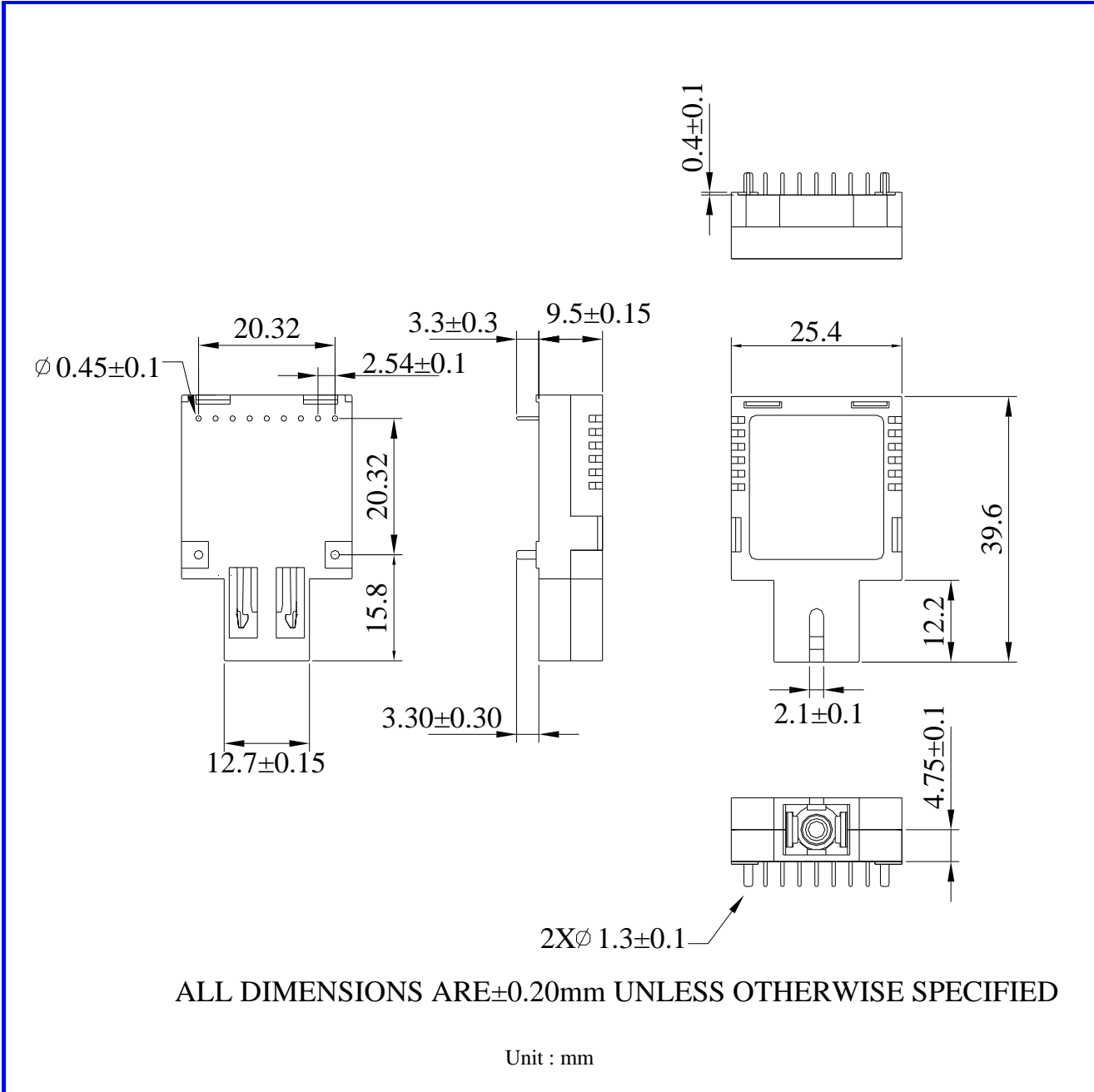
Recommended Board Layout Hole Pattern





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Drawing Dimensions



Note : All information contained in this document is subject to change without notice.